

Product Description

The PE9313 is a high-performance static UltraCMOS™ prescaler with a fixed divide ratio of 8. Its operating frequency range is DC to 1500 MHz. The PE9313 operates on a nominal 3 V supply and draws only 6.5 mA. It is packaged in a small 8-lead ceramic SOIC and is ideal for frequency scaling and clock generation solutions.

The PE9313 is manufactured in Peregrine's patented Ultra-Thin Silicon (UTSi®) CMOS process, offering the performance of GaAs with the economy and integration of conventional CMOS.

1500 MHz Low Power UltraCMOS™
Divide-by-8 Prescaler
Rad hard for Space Applications

Features

- DC to 1500 MHz operation
- Fixed divide ratio of 8
- Low-power operation: 6.5 mA typical @ 3 V
- Ultra small package: 8-lead Ceramic SOIC
- Guaranteed 100Krad(Si) Total Dose Performance
- Superior Single Event Upset Immunity

Figure 1. Functional Diagram

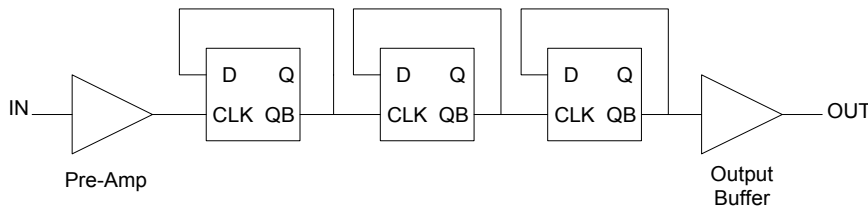


Figure 2. Package Type

8-lead CSOIC

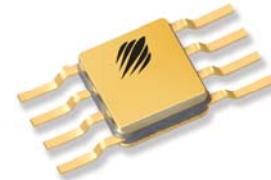
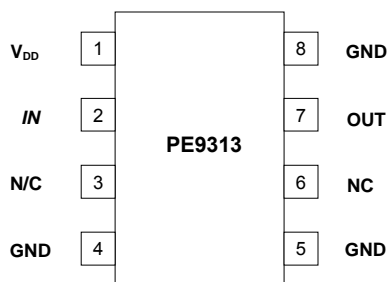


Table 1. Electrical Specifications @ +25 °C, V_{DD} = 2.6 V (Z_S = Z_L = 50 Ω)

V_{DD} = 3.0 V, -40° C ≤ T_A ≤ 85° C, unless otherwise specified

Parameter	Conditions	Minimum	Typical	Maximum	Units
Supply Voltage		2.85	3.0	3.15	V
Supply Current			6.5	11	mA
Input Frequency (F _{in})		DC		1500	MHz
Input Power (P _{in})	DC < F _{in} • 1000 MHz	-8		+10	dBm
	1000 < F _{in} • 1500 MHz	0		+10	dBm
Output Power (P _{out})	DC < F _{in} • 1500 MHz	0			dBm

Figure 3. Pin Configuration

Table 2. Pin Descriptions

Pin No.	Pin Name	Description
1	V _{DD}	Power supply pin. Bypassing is required (eg 1000 pF & 100 pF).
2	IN	Input signal pin. Should be coupled with a capacitor (eg 1000 pF).
3	NC	No connection. This pin should be left open.
4	GND	Ground pin. Ground pattern on the board should be as wide as possible to reduce ground impedance.
5	GND	Ground pin.
6	NC	No connection. This pin should be left open.
7	OUT	Divided frequency output pin. This pin should be coupled with a capacitor (eg 1000 pF).
8	GND	Ground Pin.

Table 3. Absolute Maximum Ratings

Symbol	Parameter/Conditions	Min	Max	Units
V _{DD}	Supply voltage		4.0	V
P _{in}	Input Power		15	dBm
V _{IN}	Voltage on input	-0.3	V _{DD} +0.3	V
T _{ST}	Storage temperature range	-65	150	°C
T _{OP}	Operating temperature	-40	85	°C
V _{ESD}	ESD voltage (Human Body Model, MIL-STD 883)	1000		V

Absolute Maximum Ratings are those values listed in the above table. Exceeding these values may cause permanent device damage. Functional operation should be restricted to the limits in the DC Electrical Specifications table. Exposure to absolute maximum ratings for extended periods may affect device reliability.

Electrostatic Discharge (ESD) Precautions

When handling this UltraCMOS™ device, observe the same precautions that you would use with other ESD-sensitive devices. Although this device contains circuitry to protect it from damage due to ESD, precautions should be taken to avoid exceeding the rating specified in Table 3.

Latch-Up Avoidance

Unlike conventional CMOS devices, UltraCMOS™ devices are immune to latch-up.

Device Functional Considerations

The PE9313 divides an input signal, up to a frequency of 1500 MHz, by a factor of eight thereby producing an output frequency at an eighth of the input frequency. To work properly at higher frequency, the input and output signals (pins 2 & 7) must be AC coupled via an external capacitor, as shown in the test circuit in Figure 8. The input may be DC coupled for low frequency operation with care taken to remain within the specified DC input range for the device.

The ground pattern on the board should be made as wide as possible to minimize ground impedance. See Figure 7 for a layout example.

Typical Performance Data: $V_{DD} = 3.0\text{ V}$

Figure 4. Input Sensitivity

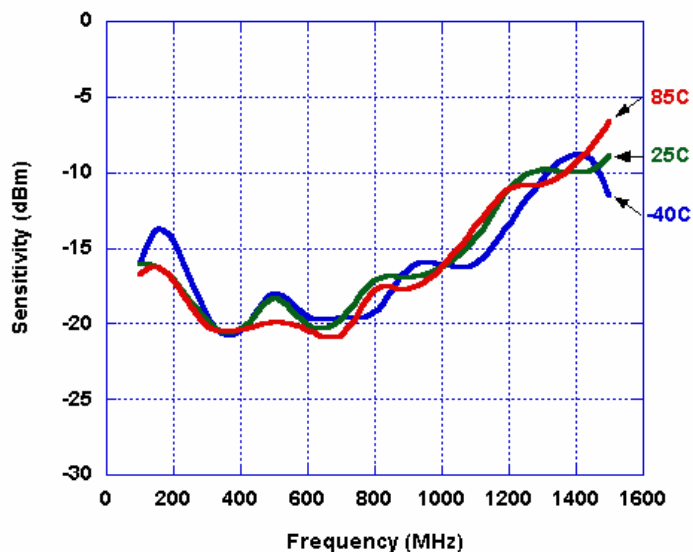


Figure 5. Device Current

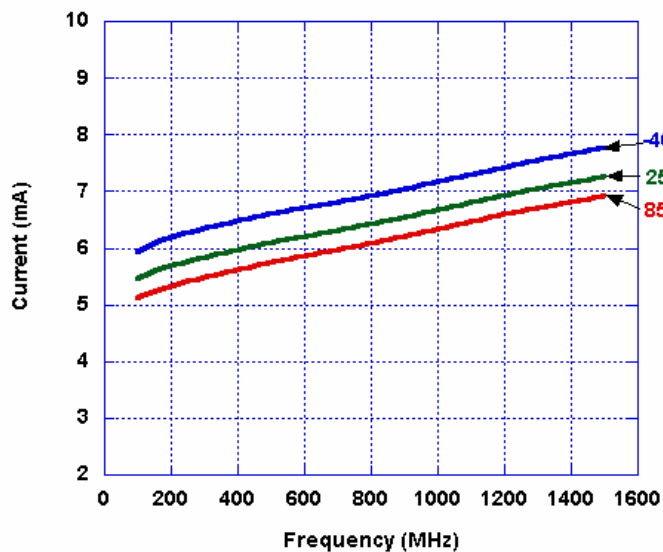


Figure 6. Output Power

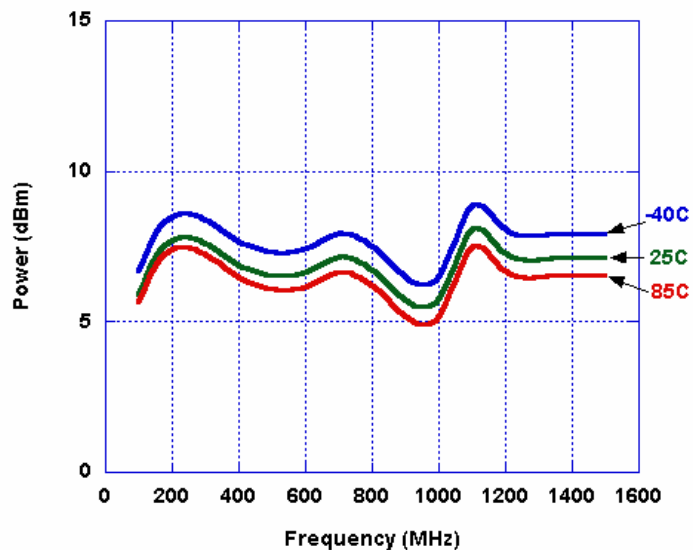
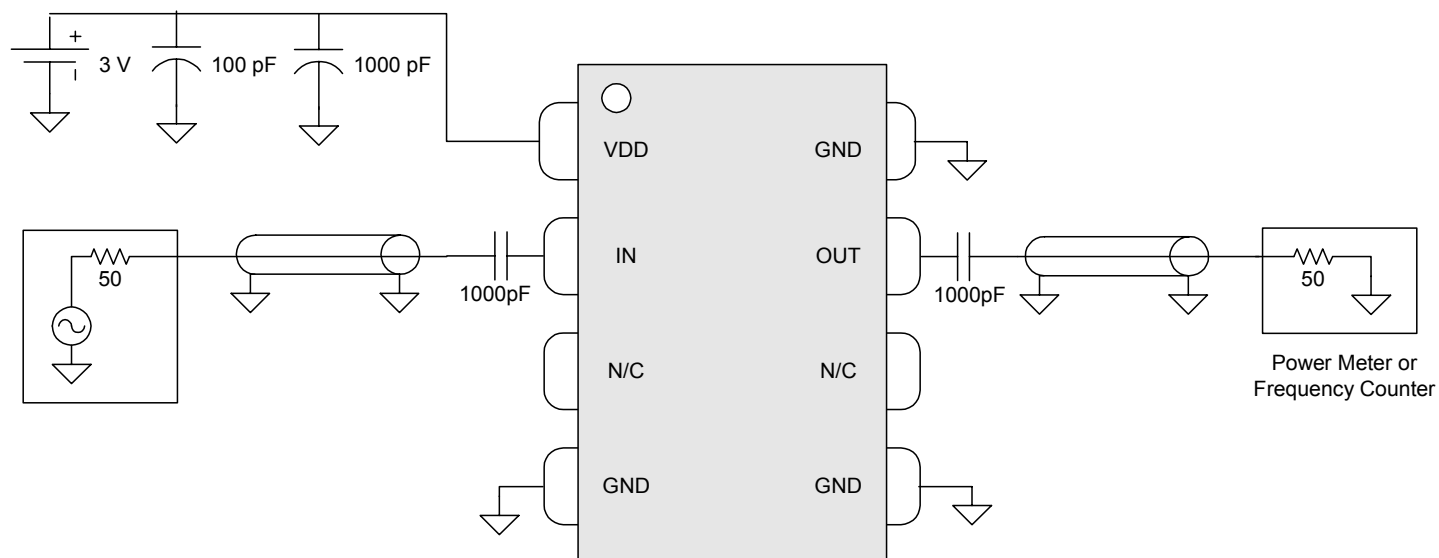


Figure 7. Test Circuit Block Diagram



The Ceramic SOIC Prescaler Evaluation Board was designed to help customers evaluate the *PE9313* divide-by-8 prescaler. On this board, the device input (pin 2) is connected to the SMA connector J1 through a 50 Ω transmission line. A series capacitor (C3) provides the necessary DC block for the device input. A value of 1000 pF was used for the evaluation board; other applications may require a different value. It is also possible to place a 0 Ω resistor in this location for very low frequency applications.

The device output (pin 7) is connected to SMA connector J3 through a 50 Ω transmission line. A series capacitor (C1) provides the necessary DC block for the device output. This capacitor value must be chosen to have a low impedance at the desired output frequency of the device. A value of 1000 pF was chosen for the evaluation board.

The board is constructed of a two-layer FR4 material with a total thickness of 0.031". The bottom layer provides ground for the RF transmission lines. The transmission lines were designed using a coplanar waveguide above ground plane model with trace width of 0.030", trace gaps of 0.0061", dielectric thickness of 0.028", metal thickness of 0.0014", and ϵ_r of 4.6. Note that the predominate mode of these transmission lines is coplanar waveguide.

J2 provides DC power to the device via pin 1. Two decoupling capacitors (C2=100 pF, C10=1000 pF) are included on this trace. It is the responsibility of the customer to determine proper supply decoupling for their design application.

Control +V

J2

RF In

Out 1

C5

C10

C12

U3

C1

C3

C8

J3

J1

J4

Peregrine Semiconductor Corp.

101/0034-02A

Frequency Divider

C4

C6

P/N: 101/0034-02A

Figure 10. Package Drawing
8-lead CSOIC

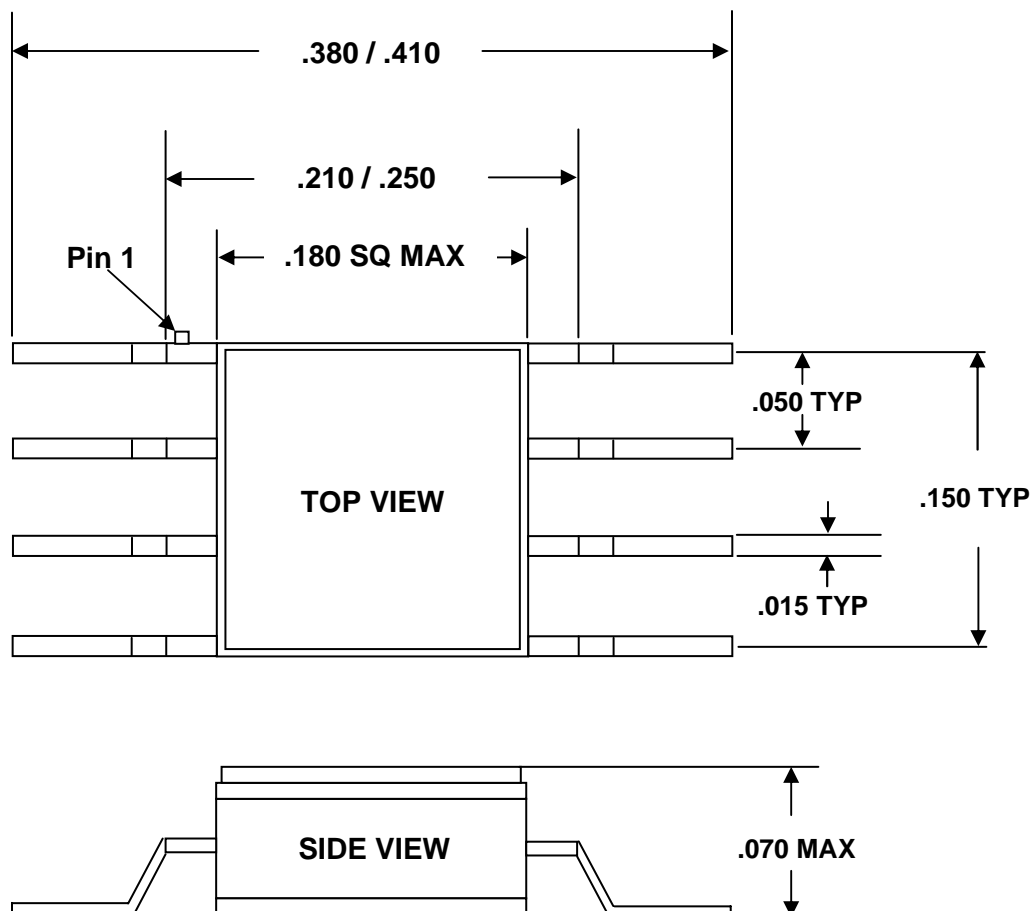


Table 4. Ordering Information

Order Code	Part Marking	Description	Package	Shipping Method
9313-01	PE9313	PE9313-08CFPG-B Engineering Samples	Gullwing Glass Flatpack	50 / Tray
9313-11	PE9313	PE9313-08CFPG-B Production Units	Gullwing Glass Flatpack	50 / Tray
9313-00	PE9313-EK	PE9313 Evaluation Kit	Evaluation Kit	1 / Box

Sales Offices

The Americas

Peregrine Semiconductor Corp.

9450 Carroll Park Drive
San Diego, CA 92121
Tel 858-731-9400
Fax 858-731-9499

Europe

Peregrine Semiconductor Europe

Commercial Products:

Bâtiment Maine
13-15 rue des Quatre Vents
F- 92380 Garches, France
Tel: +33-1-47-41-91-73
Fax : +33-1-47-41-91-73

Space and Defense Products:

180 Rue Jean de Guiramand
13852 Aix-En-Provence cedex 3, France
Tel: +33(0) 4 4239 3361
Fax: +33(0) 4 4239 7227

North Asia Pacific

Peregrine Semiconductor K.K.

5A-5, 5F Imperial Tower
1-1-1 Uchisaiwaicho, Chiyoda-ku
Tokyo 100-0011 Japan
Tel: +81-3-3502-5211
Fax: +81-3-3502-5213

South Asia Pacific

Peregrine Semiconductor

28G, Times Square,
No. 500 Zhangyang Road,
Shanghai, 200122, P.R. China
Tel: +86-21-5836-8276
Fax: +86-21-5836-7652

For a list of representatives in your area, please refer to our Web site at: www.psemi.com

Data Sheet Identification

Advance Information

The product is in a formative or design stage. The data sheet contains design target specifications for product development. Specifications and features may change in any manner without notice.

Preliminary Specification

The data sheet contains preliminary data. Additional data may be added at a later date. Peregrine reserves the right to change specifications at any time without notice in order to supply the best possible product.

Product Specification

The data sheet contains final data. In the event Peregrine decides to change the specifications, Peregrine will notify customers of the intended changes by issuing a DCN (Document Change Notice).

The information in this data sheet is believed to be reliable. However, Peregrine assumes no liability for the use of this information. Use shall be entirely at the user's own risk.

No patent rights or licenses to any circuits described in this data sheet are implied or granted to any third party.

Peregrine's products are not designed or intended for use in devices or systems intended for surgical implant, or in other applications intended to support or sustain life, or in any application in which the failure of the Peregrine product could create a situation in which personal injury or death might occur. Peregrine assumes no liability for damages, including consequential or incidental damages, arising out of the use of its products in such applications.

The Peregrine name, logo, and UTSi are registered trademarks and UltraCMOS is a trademark of Peregrine Semiconductor Corp.